DC Sputter **Coating System**





CemeCon coating systems with DC Sputter technology are especially flexible and applicable universally. For decades they have been the backbone of many tool coatings around the world. Depending on the quantities required, the ML and XL versions are available. Both of them coat quickly and easily with all nitride-, boride- and carbonbased materials. Add-on modules allow further individual adjustments.

The CC800[®]/9 ML is the economical system for medium lot quantities and frequent changes in batch and coating

material. With the optional flex module, your capacity can be further enlarged and quickly adapted to current order volume. Due to its high flexibility, the CC800[®]/9 ML line has proved its worth in research and development. The system's open, modular design allows it to be equipped with many extensions and options, such as measuring devices.

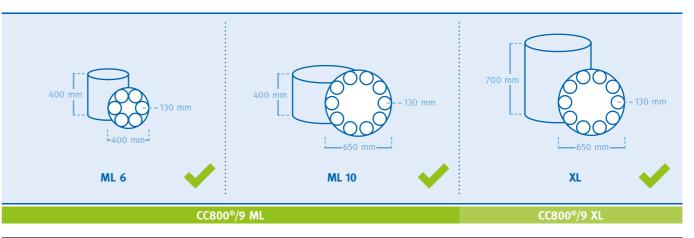
CemeCon has developed the CC800[®]/9 XL for large batch quantities or large components. With the same external dimensions as the ML model, it has considerably larger coating volume. It coats 4.500 drills or 16.400 cutting inserts and tools up

to a length of 800 milimeters and 650 millimeters in diameter in just one operation. The electro-hydraulically driven quick-change table allows fast loading and unloading of tool batches.

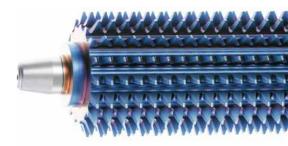
		CC800®/9 ML 6 (10)	CC800®/9 XL
Coating area Ø x h	[mm]	Ø400 x 400 (Ø650 x 400)	Ø650 x 700
Substrate table, Ø x Ø satellites x number of satellites	[mm] number	Ø400 x Ø130 x 6 (Ø650 x Ø130 x 10)	Ø650 x Ø130 x 10
Table for quick batch change		Mechanical or electro-hydraulic	Electro- hydraulic
Sputter cathodes	items [mm]	4 x 500	4 x 800
Maximum substrate dimensions Ø x h	[mm]	Ø400 x 800 (Ø650 x 800)	Ø650 x 800
Drill capacity Ø6 mm x 60 mm	item	1,800 (3,000)	4,500
Insert capacity 12.7 mm x 3.5 mm	item	4,920 (8,200)	16,400
Maximum substrate weight	[kg]	250 (500)	500
Cycle time for 3 µm Hyperlox®*	[h]	5	6
Processes		Sputtering with Booster Technology	Sputtering with Booster Technology
Substrate pre-treatment (plasma etching)		Booster and MF etching	Booster and MF etching
Electrically conductive coatings		Yes	Yes
Electrically non-conductive coatings		No	No
Electrically non-conductive substrates		No	No
Rated power	[kW]	60	80
Power consumption per batch for 3µm Hyperlox®*	[kWh]	120	200
Outer dimensions (w x l x h)	[mm³]	1,050 x 3,350 x 2,200	1,050 x 3,350 x 2,200
Weight (empty)		3,000 - 3,300	~ 3,300

* On a 10 mm milling cutter

COATING VOLUME

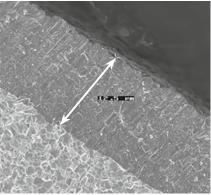


CemeCon AG | Adenauerstr. 20 A 4 | 52146 Würselen | Germany | Phone +49 2405 4470 100 | Fax +49 2405 4470 399 | info@cemecon.de | www.cemecon.com



DC-MAGNETRON-SPUTTERING





ALOX[®] SN² coating with 12.5 µm coating thickness